

# High Performance Computing (HPC) Chipset Market By Chip Type (CPU, GPU, FPGA, and ASIC): Global Opportunity Analysis and Industry Forecast, 2020–2027

https://marketpublishers.com/r/H5919CFAA3F8EN.html

Date: January 2021 Pages: 225 Price: US\$ 4,615.00 (Single User License) ID: H5919CFAA3F8EN

# **Abstracts**

The global HPC chipset market size is expected to reach \$13.68 billion by 2027 from \$4.30 billion in 2019, growing at a CAGR of 19.1% from 2020 to 2027. High performance computing (HPC) has a capability to process large datasets and perform complex calculations at high speeds. It usually refers to the practice of aggregating computing power in a way, which provides much higher performance than typical desktop computers or workstations to solve large problems in science, engineering, or business.

The CPU segment impacted negatively, due to COVID-19.

One of the best-known examples of HPC solutions is the supercomputer, which contains thousands of compute nodes that work together to complete one or more tasks. This is called parallel processing, which is similar to having thousands of PCs networked together, and combining compute power to complete tasks faster. Over the last decade, the HPC industry has witnessed use of graphical processing unit (GPU) in non-graphic applications such as general-purpose computing and programming languages & tools.

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Presently, the GPU segment has matured and is extensively used in both commercial &



scientific applications. Massive parallel processing capability of GPU drives its growth in the HPC chipset industry. GPU has rapidly evolved to become high performance accelerators for data- parallel computing. In addition, modern GPUs contain hundreds of processing units, which are capable of achieving up to 1 TFLOPS for single-precision (SP) arithmetic.

The most prominent factor that drives growth of the HPC chipset market include empowering high performance computing in the cloud sector. Cloud offers instantly available and scalable computing resources and almost unlimited storage at a reasonable cost. With the use of HPC in cloud, it helps to elevate performance, control costs, accelerate results, and run complex simulations against large datasets in fields such as aerodynamics, physics or pharmaceuticals; government initiatives; and increase in need for flexible computing services. HPC computing requires continuous efficiency & working of HPC clusters. Thus, HPC services enable complete control for users over computing infrastructure such as analysis software and operating systems.

In addition, flexible computing meets growth in demand from multinational corporations for networked cloud infrastructure services from single communication and IT services providers. Flexible computing offers a scalable and modular service for fast and easy provisioning of resources, which can scale up and down to meet fluctuating demand and dynamic business growth.

However, one of the major restraints of the market is high cost for setting and maintaining HPCs. There is a high capital expenditure involved, including hardware and software costs. The high cost of initial investments in HPC computing as well as maintenance restricts startups and SMEs from adopting the same. On the contrary, increasing focus toward hybrid HPC infrastructure is anticipated to provide lucrative opportunities for the industry.

Hybrid approach allows applications and components to interoperate across boundaries, between cloud instances and between architectures. A hybrid HPC infrastructure results in better efficiency, scalability, enhanced security, and better technology. Apart from this, it also resolves security and privacy concerns as well as lowers the maintenance cost. Therefore, rise in focus toward hybrid HPC infrastructure is expected to provide lucrative opportunities for the HPC chipset market.

High Performance Computing (HPC) Chipset Market

### By Chip Type



CPU segment would grow at a highest CAGR of 25.8% during the forecast period

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### Segment Overview

The global HPC chipset market is segmented into chip type and region. On the basis of chip type, it is classified into CPU, GPU, FPGA, and ASIC. Region wise, the HPC chipset market trends analyzed across North America (U.S., Canada, and Mexico), Europe (UK, Germany, Italy, France, Spain, and rest of Europe), Asia-Pacific (China, Japan, India, South Korea, and rest of Asia-Pacific), and LAMEA (Latin America, Middle East, and Africa). North America accounted for the highest share, owing to high development of supercomputers in the region.

High Performance Computing (HPC) Chipset Market

By Geography

2027 Asia-pacific

North America

Europe

Lamea

Asia-Pacific region would dominate the market with a highest CAGR of 20.0% during 2020 - 2027

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**Top Impacting Factors** 

The most prominent factor that drives growth of the HPC chipset market includes empowering HPC in the cloud sector, government initiatives, and increase in need for



flexible computing services are the prominent factors that propel the HPC chipset market growth. However, high cost of HPC chipset restricts the market growth. Conversely, rise in focus toward hybrid HPC infrastructure is expected to create lucrative opportunities for the industry.

### **Competitive Analysis**

Competitive analysis and profiles of the top key players such as Advanced Micro Devices (AMD), IBM, Hewlett Packard Enterprise (HPE), Intel Corporation, NVIDIA Corporation, Alphabet, Achronix Semiconductor, Cisco System, MediaTek Inc., and Lattice Semiconductor Corporation are provided in this report. These key players have adopted various strategies, such as product portfolio expansion, mergers & acquisitions, agreements, geographical expansion, and collaborations, to increase their market penetration and strengthen their foothold in the industry.

### COVID-19 Impact Analysis

The global HPC chipset market size has been significantly impacted by the COVID-19 outbreak. New projects throughout the world have been stalled which, in turn, has declined the market growth. Moreover, owing to this pandemic, end-use industries are facing major challenges, which may slow down growth of the HPC chipset market.

The impact of COVID-19 on the HPC chipset market is temporary as just production and supply chain is stalled. Once the situation improves, production, supply chains, and demand for these products are expected to gradually increase. The current scenario is expected to provide opportunities for companies to think about ways to increase their production, research about technologies, and improve current products.

Some the leading countries such as the U.S., Japan, and Australia have joined the COVID-19 high performance computing consortium. The consortium pools supercomputing power and offers it to researchers to fight against the pandemic. In addition, this consortium would help aggregate computing capabilities from some of the most powerful and advanced computers in the world to help researchers everywhere better understand COVID-19, its causes, and potential cures.

### Key Benefits For Stakeholders

This study comprises analytical depiction of the global HPC chipset market outlook along with the current trends and future



estimations to depict the imminent investment pockets.

The overall HPC chipset market analysis is determined to understand the profitable trends to gain a stronger foothold.

The report presents information related to key drivers, restraints, and HPC chipset market opportunities with a detailed impact analysis.

The current HPC chipset market forecast is quantitatively analyzed from 2019 to 2027 to benchmark the financial competency.

Porter's five forces analysis illustrates the potency of the buyers and the HPC chipset market share of key vendors.

The report includes the market trends and the market share of key vendors.

HPC Chipset Market Key Segments

#### By Chip Type

CPU

GPU

FPGA

ASIC

By Region

North America

U.S.



#### Canada

Mexico

### Europe

UK

Germany

Italy

France

Spain

### Rest of Europe

#### Asia-Pacific

China

### Japan

#### India

South Korea

**Rest of Asia-Pacific** 

### LAMEA

Latin America

Middle East

Africa



### Key Market Players

### Advanced Micro Devices (AMD)

IBM

Hewlett Packard Enterprise (HPE)

**Intel Corporation** 

NVIDIA Corporation

Alphabet

Achronix Semiconductor

Cisco System

MediaTek Inc.

Lattice Semiconductor Corporation



# Contents

### CHAPTER 1:INTRODUCTION

- 1.1.Report description
- 1.2.Key benefits for stakeholders
- 1.3.Key market segments
- 1.4.Research methodology
- 1.4.1.Primary research
- 1.4.2.Secondary research
- 1.4.3.Analyst tools and models

### CHAPTER 2: EXECUTIVE SUMMARY

2.1.CXO perspective

### **CHAPTER 3:MARKET OVERVIEW**

- 3.1.Market definition and scope
- 3.2.Key findings
  - 3.2.1.Top impacting factors
  - 3.2.2.Top investment pockets
- 3.3. Porter's five forces analysis
- 3.4.Patent analysis
  - 3.4.1.By Region (2012-2020)
  - 3.4.2.By applicant (2012-2020)
- 3.5.Market dynamics
  - 3.5.1.Drivers
  - 3.5.1.1.Empowering high-performance computing in the cloud sector
  - 3.5.1.2. Government Initiatives
  - 3.5.1.3. Increase in need for flexible computing services
  - 3.5.2.Restraint
  - 3.5.2.1. High cost of high-performance computing
  - 3.5.3.Opportunity
  - 3.5.3.1. Increasing focus towards the hybrid HPC infrastructure
- 3.6.Impact of COVID-19 on HPC chipset market
  - 3.6.1.COVID-19 Outbreak
  - 3.6.2.Impact on Market Size
  - 3.6.3.End User Trends, Preference, and Budget Impact



3.6.4.Key Player Strategy

3.7.GPU-STYLE ACCELERATORS: PRICING ANALYSIS (ASP)

3.8.AVERAGE MEMORY SIZE OF GPU ACCELERATOR

3.8.1.ASP VS GPU Memory Size (Capacity)

# CHAPTER 4: GLOBAL HPC CHIPSET MARKET, BY CHIP TYPE

- 4.1.Overview
- 4.2.COMPARATIVE ANALYSIS
- 4.3.CPU
  - 4.3.1.Key market trends, growth factors and opportunities
  - 4.3.2.Market size and forecast, by region
- 4.3.3.Market analysis by country

4.4.GPU

- 4.4.1.Key market trends, growth factors and opportunities
- 4.4.2.Market size and forecast, by region
- 4.4.3.Market analysis by country

4.5.FPGA

- 4.5.1.Key market trends, growth factors and opportunities
- 4.5.2. Market size and forecast, by region
- 4.5.3.Market analysis by country

4.6.ASIC

- 4.6.1.Key market trends, growth factors and opportunities
- 4.6.2. Market size and forecast, by region
- 4.6.3. Market analysis by country

# CHAPTER 5: HPC CHIPSET MARKET, BY REGION

- 5.1.Overview
- 5.2.North America
  - 5.2.1.Key market trends, growth factors, and opportunities
  - 5.2.2.Market size and forecast, by chip type
    - 5.2.2.1.U.S.
    - 5.2.2.1.1.Market size and forecast, by chip type
    - 5.2.2.2.Canada
    - 5.2.2.2.1.Market size and forecast, by chip type
    - 5.2.2.3.Mexico
  - 5.2.2.3.1.Market size and forecast, by chip type
- 5.3.Europe



- 5.3.1.Key market trends, growth factors, and opportunities
- 5.3.2.Market size and forecast, by chip type
- 5.3.3.Market analysis by country
  - 5.3.3.1.UK
  - 5.3.3.1.1.Market size and forecast, by chip type
  - 5.3.3.2.Germany
  - 5.3.3.2.1.Market size and forecast, by chip type
  - 5.3.3.3.Italy
  - 5.3.3.3.1.Market size and forecast, by chip type
  - 5.3.3.4.France
  - 5.3.3.4.1.Market size and forecast, by chip type
  - 5.3.3.5.Spain
  - 5.3.3.5.1.Market size and forecast, by chip type
  - 5.3.3.6.Rest of Europe
  - 5.3.3.6.1.Market size and forecast, by chip type
- 5.4.Asia-Pacific
  - 5.4.1.Key market trends, growth factors, and opportunities
  - 5.4.2.Market size and forecast, by chip type
  - 5.4.3. Market analysis by country
    - 5.4.3.1.China
    - 5.4.3.1.1.Market size and forecast, by chip type
    - 5.4.3.2.Japan
    - 5.4.3.2.1.Market size and forecast, by chip type
    - 5.4.3.3.India
    - 5.4.3.3.1.Market size and forecast, by chip type
    - 5.4.3.4.South Korea
    - 5.4.3.4.1.Market size and forecast, by chip type
  - 5.4.3.5.Rest of Asia-Pacific
  - 5.4.3.5.1.Market size and forecast, by chip type
- 5.5.LAMEA
  - 5.5.1.Key market trends, growth factors, and opportunities
  - 5.5.2.Market size and forecast, by chip type
  - 5.5.3.Market analysis by country
  - 5.5.3.1.Latin America
  - 5.5.3.1.1.Market size and forecast, by chip type
  - 5.5.3.2.Middle East
  - 5.5.3.2.1. Market size and forecast, by chip type
  - 5.5.3.3.Africa
  - 5.5.3.3.1.Market size and forecast, by chip type



### CHAPTER 6:COMPETITIVE LANDSCAPE

- 6.1.Introduction
- 6.1.1.Market player positioning, 2020
- 6.2. Top winning strategies
- 6.3. Product mapping of top 10 player
- 6.4.Competitive dashboard
- 6.5.Competitive heatmap

### **CHAPTER 7: COMPANY PROFILES**

### 7.1.ADVANCED MICRO DEVICES, INC.

- 7.1.1.Company overview
- 7.1.2.Company snapshot
- 7.1.3. Operating business segments
- 7.1.4. Product portfolio
- 7.1.5.Research and Development
- 7.1.6.Business performance
- 7.1.7.Key strategic moves and developments
- 7.2.INTEL CORPORATION
  - 7.2.1.Company overview
  - 7.2.2.Company snapshot
  - 7.2.3.Operating business segments
  - 7.2.4. Product portfolio
  - 7.2.5.R&D Expenditure
  - 7.2.6.Business performance
  - 7.2.7.Key strategic moves and developments
- 7.3. INTERNATIONAL BUSINESS MACHINES CORPORATION (IBM)
  - 7.3.1.Company overview
  - 7.3.2.Company snapshot
  - 7.3.3.Operating business segments
  - 7.3.4. Product portfolio
  - 7.3.5.R&D
  - 7.3.6.Business performance
  - 7.3.7.Key strategic moves and developments
- 7.4.CISCO SYSTEMS, INC.
  - 7.4.1.Company overview
  - 7.4.2.Key executives



- 7.4.3.Company snapshot
- 7.4.4.Operating business segments
- 7.4.5.Product portfolio
- 7.4.6.R&D Expenditure
- 7.4.7.Business performance
- 7.4.8.Key strategic moves and developments
- 7.5.Hewlett Packard Enterprise Development LP
  - 7.5.1.Company overview
  - 7.5.2.Key executives
  - 7.5.3.Company snapshot
  - 7.5.4.Operating business segments
  - 7.5.5.Product portfolio
  - 7.5.6.R&D expenditure
  - 7.5.7.Business performance
  - 7.5.8.Key strategic moves and developments
- 7.6.NVIDIA CORPORATION
- 7.6.1.Company overview
- 7.6.2.Company snapshot
- 7.6.3.Operating business segments
- 7.6.4. Product portfolio
- 7.6.5.Research and Development
- 7.6.6.Business performance
- 7.6.7.Key strategic moves and developments
- 7.7.MEDIATEK INC
  - 7.7.1.Company overview
  - 7.7.2.Company snapshot
  - 7.7.3.Product portfolio
  - 7.7.4.Research & Development
  - 7.7.5.Business performance
- 7.7.6.Key strategic moves and developments
- 7.8. Achronix Semiconductor Corp.
  - 7.8.1.Company overview
  - 7.8.2.Key Executives
  - 7.8.3.Company snapshot
  - 7.8.4.Operating business segments
  - 7.8.5.Product portfolio
  - 7.8.6.Key strategic moves and developments
- 7.9.Alphabet Inc.
  - 7.9.1.Company overview



- 7.9.2.Key Executives
- 7.9.3.Company snapshot
- 7.9.4.Operating business segments
- 7.9.5.Product portfolio
- 7.9.6.R&D Expenditure
- 7.9.7.Business performance
- 7.9.8.Key strategic moves and developments
- 7.10.Lattice Semiconductor Corporation.
  - 7.10.1.Company overview
  - 7.10.2.Key Executives
  - 7.10.3.Company snapshot
  - 7.10.4. Operating business segments
  - 7.10.5. Product portfolio
  - 7.10.6.R&D Expenditure
  - 7.10.7.Business performance
  - 7.10.8.Key strategic moves and developments



# **List Of Tables**

## LIST OF TABLES

TABLE 01.GLOBAL HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 02.HPC CHIPSET MARKET REVENUE FOR CPU, BY REGION, 2019–2027 (\$MILLION)

TABLE 03.HPC CHIPSET MARKET REVENUE FOR GPU, BY REGION 2019-2027 (\$MILLION)

TABLE 04.HPC CHIPSET MARKET REVENUE FOR FPGA, BY REGION, 2019–2027 (\$MILLION)

TABLE 05.HPC CHIPSET MARKET REVENUE FOR ASIC, BY REGION, 2019–2027 (\$MILLION)

TABLE 06.NORTH AMERICA HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION)

TABLE 07.U. S. HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 08.CANADA HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 09.MEXICO HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 10.EUROPE HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 11.UK HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 12.GERMANY HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION)

TABLE 13.ITALY HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 14.FRANCE HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 15.SPAIN HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 16.REST OF EUROPE HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION)

TABLE 17.ASIA-PACIFIC HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION)

TABLE 18.CHINA HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 19.JAPAN HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 20.INDIA HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 21.SOUTH KOREA HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION)

TABLE 22.REST OF ASIA-PACIFIC HPC CHIPSET MARKET, BY CHIP TYPE,2019–2027 (\$MILLION)

TABLE 23.LAMEA HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 24.LATIN AMERICA HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION)



TABLE 25.MIDDLE EAST HPC CHIPSET MARKET. BY CHIP TYPE. 2019–2027 (\$MILLION) TABLE 26.AFRICA HPC CHIPSET MARKET, BY CHIP TYPE, 2019–2027 (\$MILLION) TABLE 27.AMD: COMPANY SNAPSHOT TABLE 28.AMD: OPERATING SEGMENTS TABLE 29.AMD: PRODUCT PORTFOLIO TABLE 30.INTEL CORPORATION: COMPANY SNAPSHOT TABLE 31.INTEL CORPORATION: OPERATING SEGMENTS TABLE 32.INTEL CORPORATION: PRODUCT PORTFOLIO TABLE 33.INTEL CORPORATION: KEY STRATEGIC MOVES AND DEVELOPMENTS TABLE 34.INTERNATIONAL BUSINESS MACHINES CORPORATION (IBM): COMPANY SNAPSHOT TABLE 35.INTERNATIONAL BUSINESS MACHINES CORPORATION (IBM): **OPERATING SEGMENTS** TABLE 36.INTERNATIONAL BUSINESS MACHINES CORPORATION (IBM): **PRODUCT PORTFOLIO** TABLE 37. INTERNATIONAL BUSINESS MACHINES CORPORATION (IBM): KEY STRATEGIC MOVES AND DEVELOPMENTS TABLE 38.CISCO SYSTEMS, INC.: KEY EXECUTIVES TABLE 39.CISCO SYSTEMS, INC.: COMPANY SNAPSHOT TABLE 40.CISCO SYSTEMS, INC.: PRODUCT CATEGORIES TABLE 41.CISCO SYSTEMS, INC.: PRODUCT PORTFOLIO TABLE 42.CISCO SYSTEMS, INC.: KEY STRATEGIC MOVES AND DEVELOPMENTS TABLE 43.HEWLETT PACKARD ENTERPRISE DEVELOPMENT LP: KEY EXECUTIVES TABLE 44.HEWLETT PACKARD ENTERPRISE DEVELOPMENT LP: COMPANY **SNAPSHOT** TABLE 45.HEWLETT PACKARD ENTERPRISE DEVELOPMENT LP: OPERATING SEGMENTS TABLE 46.HEWLETT PACKARD ENTERPRISE DEVELOPMENT LP: PRODUCT PORTFOLIO TABLE 47.HEWLETT PACKARD ENTERPRISE DEVELOPMENT LP: KEY STRATEGIC MOVES AND DEVELOPMENTS TABLE 48.NVIDIA: COMPANY SNAPSHOT TABLE 49.NVIDIA: OPERATING SEGMENTS TABLE 50.NVIDIA: PRODUCT PORTFOLIO TABLE 51.MEDIATEK INC: COMPANY SNAPSHOT TABLE 52.MEDIATEK INC: PRODUCT PORTFOLIO TABLE 53.MEDIATEK INC: KEY STRATEGIC MOVES AND DEVELOPMENTS



TABLE 54.ACHRONIX SEMICONDUCTOR: KEY EXECUTIVES TABLE 55.ACHRONIX SEMICONDUCTOR: COMPANY SNAPSHOT TABLE 56.ACHRONIX SEMICONDUCTOR: OPERATING SEGMENTS TABLE 57.ACHRONIX SEMICONDUCTOR: PRODUCT PORTFOLIO TABLE 58.ACHRONIX SEMICONDUCTOR: KEY STRATEGIC MOVES AND **DEVELOPMENTS** TABLE 59.ALPHABET INC: KEY EXECUTIVES TABLE 60.ALPHABET INC: COMPANY SNAPSHOT TABLE 61.ALPHABET INC: OPERATING SEGMENTS TABLE 62.ALPHABET INC: PRODUCT PORTFOLIO TABLE 63.ALPHABET INC: KEY STRATEGIC MOVES AND DEVELOPMENTS TABLE 64.LATTICE SEMICONDUCTOR CORPORATION: KEY EXECUTIVES TABLE 65.LATTICE SEMICONDUCTOR CORPORATION: COMPANY SNAPSHOT TABLE 66.LATTICE SEMICONDUCTOR CORPORATION: OPERATING SEGMENTS TABLE 67.LATTICE SEMICONDUCTOR CORPORATION: PRODUCT PORTFOLIO TABLE 68.ALPHABET INC: KEY STRATEGIC MOVES AND DEVELOPMENTS



# **List Of Figures**

### LIST OF FIGURES

FIGURE 01.KEY MARKET SEGMENTS FIGURE 02. EXECUTIVE SUMMARY, BY SEGMENT FIGURE 03. EXECUTIVE SUMMARY, BY REGION FIGURE 04. TOP IMPACTING FACTORS FIGURE 05.TOP INVESTMENT POCKETS FIGURE 06.MODERATE-TO-HIGH BARGAINING POWER OF SUPPLIERS FIGURE 07.MODERATE THREAT OF NEW ENTRANTS FIGURE 08. HIGH-TO-MODERATE THREAT OF SUBSTITUTES FIGURE 09. HIGH TO MODERATE INTENSITY OF RIVALRY FIGURE 10.MODERATE TO HIGH BARGAINING POWER OF BUYERS FIGURE 11.PATENT ANALYSIS, BY COUNTRY FIGURE 12. PATENT ANALYSIS, BY APPLICANT FIGURE 13.GLOBAL HPC CHIPSET MARKET SHARE, BY CHIP TYPE, 2019–2027 (%) FIGURE 14.COMPARATIVE SHARE ANALYSIS OF HPC CHIPSET MARKET FOR CPU, BY COUNTRY, 2019 & 2027 (%) FIGURE 15. COMPARATIVE SHARE ANALYSIS OF HPC CHIPSET MARKET FOR GPU, BY COUNTRY, 2019 & 2027 (%) FIGURE 16.COMPARATIVE SHARE ANALYSIS OF HPC CHIPSET MARKET FOR FPGA, BY COUNTRY, 2019 & 2027 (%) FIGURE 17. COMPARATIVE SHARE ANALYSIS OF HPC CHIPSET MARKET FOR ASIC, BY COUNTRY, 2019 & 2027 (%) FIGURE 18.HPC CHIPSET MARKET, BY REGION, 2019-2027 (%) FIGURE 19. COMPARATIVE SHARE ANALYSIS OF NORTH AMERICA HPC CHIPSET MARKET, BY COUNTRY, 2019-2027 (%) FIGURE 20.U. S. HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 21.CANADA HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 22.MEXICO HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 23.COMPARATIVE SHARE ANALYSIS OF EUROPE HPC CHIPSET MARKET, BY COUNTRY, 2019–2027 (%) FIGURE 24.UK HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 25.GERMANY HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 26.ITALY HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 27.FRANCE HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 28.SPAIN HPC CHIPSET MARKET, 2019–2027 (\$MILLION)



FIGURE 29.REST OF EUROPE HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 30.COMPARATIVE SHARE ANALYSIS OF ASIA-PACIFIC HPC CHIPSET MARKET, BY COUNTRY, 2019–2027 (%) FIGURE 31.CHINA HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 32.JAPAN HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 33.INDIA HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 34.SOUTH KOREA HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 35.REST OF ASIA-PACIFIC HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 36.COMPARATIVE SHARE ANALYSIS OF LAMEA HPC CHIPSET MARKET, BY COUNTRY, 2019–2027 (%) FIGURE 37.LATIN AMERICA HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 38.MIDDLE EAST HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 39.AFRICA HPC CHIPSET MARKET, 2019–2027 (\$MILLION) FIGURE 40.MARKET PLAYER POSITIONING, 2020 FIGURE 41.TOP WINNING STRATEGIES, BY YEAR, 2017-2021\* FIGURE 42.TOP WINNING STRATEGIES, BY DEVELOPMENT, 2017-2021\* FIGURE 43.TOP WINNING STRATEGIES, BY COMPANY, 2017-2021\* FIGURE 44.PRODUCT MAPPING OF TOP 10 PLAYERS FIGURE 45.COMPETITIVE DASHBOARD OF KEY PLAYER FIGURE 46.COMPETITIVE HEATMAP OF KEY PLAYERS FIGURE 47.AMD: R&D, 2017–2019 (\$MILLION) FIGURE 48.AMD: NET SALES, 2017-2019 (\$MILLION) FIGURE 49.AMD: REVENUE SHARE BY SEGMENT, 2018 (%) FIGURE 50.AMD: REVENUE SHARE BY REGION, 2018 (%) FIGURE 51.R&D EXPENDITURE, 2017–2019 (\$BILLION) FIGURE 52.INTEL CORPORATION: NET SALES, 2017–2019 (\$MILLION) FIGURE 53.INTEL CORPORATION: REVENUE SHARE BY SEGMENT, 2019 (%) FIGURE 54.INTEL CORPORATION: REVENUE SHARE BY REGION, 2019 (%) FIGURE 55.INTERNATIONAL BUSINESS MACHINES CORPORATION (IBM): R&D, 2017-2019(\$MILLION) FIGURE 56.INTERNATIONAL BUSINESS MACHINES CORPORATION (IBM): REVENUE, 2017–2019(\$MILLION) FIGURE 57.INTERNATIONAL BUSINESS MACHINES CORPORATION (IBM): REVENUE SHARE BY SEGMENT, 2019 (%) FIGURE 58.INTERNATIONAL BUSINESS MACHINES CORPORATION (IBM): REVENUE SHARE BY REGION, 2019 (%) FIGURE 59.CISCO SYSTEMS, INC.: R&D EXPENDITURE, 2018–2020 (\$MILLION)

FIGURE 60.CISCO SYSTEMS, INC.: REVENUE, 2018–2020 (\$MILLION)



FIGURE 61.CISCO SYSTEMS, INC.: REVENUE SHARE BY SEGMENT, 2020 (%) FIGURE 62.CISCO SYSTEMS, INC.: REVENUE SHARE BY REGION, 2020 (%) FIGURE 63.R&D EXPENDITURE, 2018–2020 (\$BILLION) FIGURE 64.HEWLETT PACKARD ENTERPRISE DEVELOPMENT LP: REVENUE, 2018–2020 (\$BILLION) FIGURE 65.HEWLETT PACKARD ENTERPRISE DEVELOPMENT LP: REVENUE SHARE BY SEGMENT, 2020 (%) FIGURE 66.HEWLETT PACKARD ENTERPRISE DEVELOPMENT LP: REVENUE SHARE BY REGION, 2020 (%) FIGURE 67.NVIDIA: R&D, 2017–2019 (\$MILLION) FIGURE 68.NVIDIA: NET SALES, 2017–2019 (\$MILLION) FIGURE 69.NVIDIA: REVENUE SHARE BY SEGMENT, 2019 (%) FIGURE 70.NVIDIA: REVENUE SHARE BY MARKET, 2019 (%) FIGURE 71.NVIDIA: REVENUE SHARE BY REGION, 2019 (%) FIGURE 72.MEDIATEK INC: R&D, 2017–2019 (\$MILLION) FIGURE 73.MEDIATEK INC: REVENUE, 2017–2019 (\$MILLION) FIGURE 74.MEDIATEK INC: REVENUE SHARE BY REGION, 2019 (%) FIGURE 75.ALPHABET INC, 2017–2019 (\$MILLION) FIGURE 76.ALPHABET INC: REVENUE, 2017–2019 (\$MILLION) FIGURE 77.ALPHABET INC: REVENUE SHARE BY SEGMENT, 2019 (%) FIGURE 78.ALPHABET INC: REVENUE SHARE BY REGION, 2019 (%) FIGURE 79.LATTICE SEMICONDUCTOR CORPORATION: 2017–2019 (\$MILLION) FIGURE 80.LATTICE SEMICONDUCTOR CORPORATION: REVENUE, 2017-2019 (\$MILLION) FIGURE 81.LATTICE SEMICONDUCTOR CORPORATION: REVENUE SHARE BY SEGMENT, 2019 (%)

FIGURE 82.LAATICE SEMICONDUCTOR CORPORATION: REVENUE SHARE BY REGION, 2019 (%)



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